Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	21413	semiconductor adj package	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:12
L2	1043	dicing adj tape	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:12
L3	14884	grind$3 same substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:13
L4	10	1 and 2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:14
L5	70	1 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:14
L6	314587	grinding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:14
L7	1001121	adhesive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:15
L8	15	5 and 6 and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:20
L9	99	2 and 3 and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:44

L10	2172	29/25.01.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:29
L11	1	8 and 10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:29
L12	7365	29/827.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:30
L13	0	12 and 9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:30
L14	1	12 and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:30
L15	1182	438/464.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:31
L16	649	438/458.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:31
L17	74	15 and 16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:31
L18	662	438/462.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:31
L19	10	17 and 18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:33

L20	2	"6297131".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:33
L21	2	("5960260" | "6048749").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:33
L22	4	("5171712" | "5273938" | "5344524" | "5457072").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:34
L23	16	("5171712").URPN.	USPAT	OR	OFF	2005/05/18 18:35
L24	4	("5171712" | "5273938" | "5344524" | "5457072").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:37
L25	7	("4771016" | "4883251" | "4983251" | "5013681" | "5032544" | "5240876" | "5258323").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:39
L26	829	438/758.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:39
L27	815	438/460.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:40
L28	1	26 and 27 and 6 and 7	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:40
L29	99	2 and 3 and 7 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:44
L30	10	("5087585" | "5268065" | "5389182" | "5411921" | "5457072" | "5632667" | "5637395" | "5731243" | "5773362" | "5986338").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:47
L31	0	chungcheongnam-do.inv.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:48
L32	33553	dong-kuk kim.inv.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:49
L33	1	32 and 8	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:49
L34	0	32 and 2 and 3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:49

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L15	1182	438/464.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:31
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L19	10	17 and 18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:33

L20	2	"6297131".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/05/18 18:33
L21	2	("5960260" | "6048749").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:33
L22	4	("5171712" | "5273938" | "5344524" | "5457072").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:34
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L25	7	("4771016" | "4883251" | "4983251" | "5013681" | "5032544" | "5240876" | "5258323").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:39
L26	829	438/758.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:39
L27	815	438/460.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:40
L28	1	26 and 27 and 6 and 7	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:40
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L30	10	("5087585" | "5268065" | "5389182" | "5411921" | "5457072" | "5632667" | "5637395" | "5731243" | "5773362" | "5986338").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:47
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L33	1	32 and 8	US-PGPUB; USPAT; USOCR	OR	OFF	2005/05/18 18:49
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